Third Quarter FY 2016 Quarterly Update

Infineon Technologies AG Investor Relations



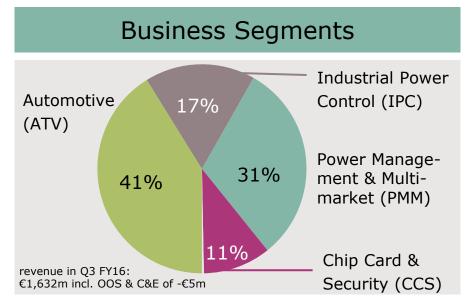


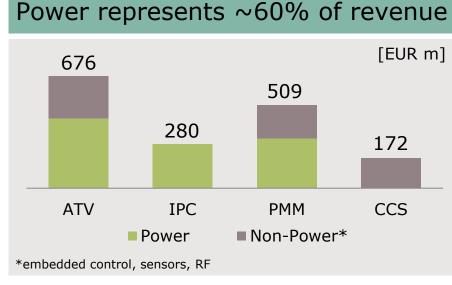
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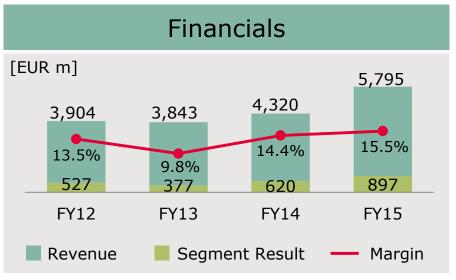
- 1 Infineon at a Glance
- 2 Planned acquisition of Wolfspeed
- 3 Growth Drivers
- 4 Results and Outlook



Infineon at a glance









Technology leadership and system understanding fosters growth and profitability



Competitive advantages

Auto

system leader in automotive

ower

#1, system and technology leader

R

broadest technology portfolio;#1 in SiGe; become #1 in base stations by 2020

Security

Leader in security solutions

Average-cycle financial targets

Revenue Growth:

~8%

Segment Result Margin:

~15%

Investment-to-Sales:

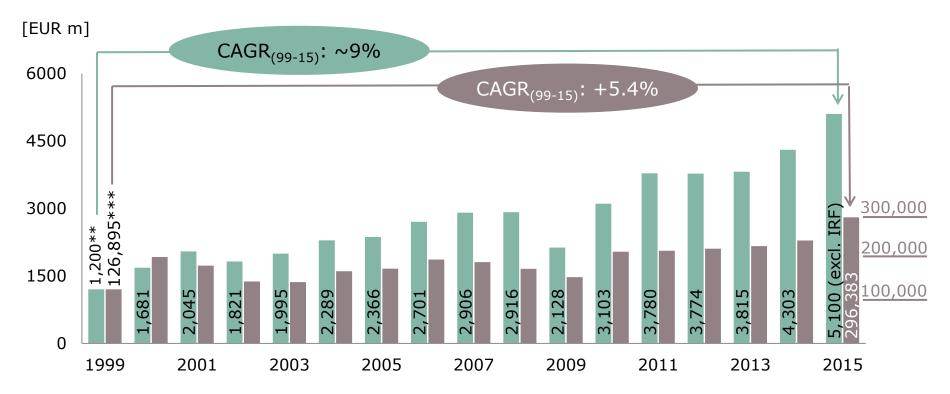
~13%

(Capex*: ~11%; capital. R&D*: ~2%)

* Infineon reports under IRFS

Infineon's Revenue Development (excl. IRF) Outperformed Total Semi Market





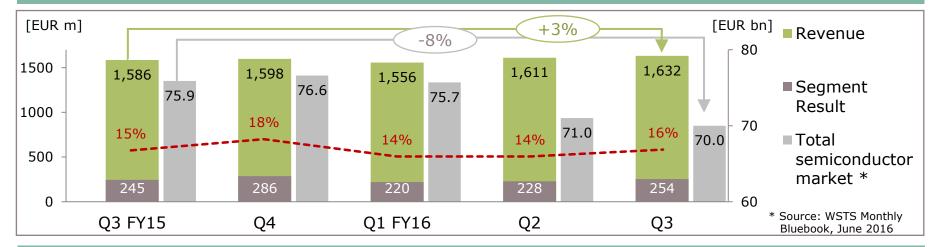
- Revenue Infineon* [lhs]
- Semiconductor World Market (adjusted for the Infineon fiscal year ending Sep 30) [rhs]
- * Based on Infineon's portfolio (excl. Other Operating Segments and Corporate & Eliminations) per end of 2015 fiscal year.
- ** Based on market development assumptions FY99's revenue figures for some smaller product categories have been derived from the FY00's revenue figures.
- *** Scale indexed to the Infineon FY99 revenue.

Source: Infineon; WSTS (World Semiconductor Trade Statistics), November 2015

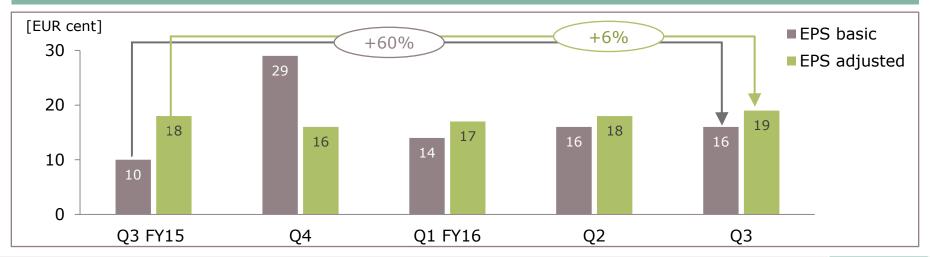
Our promise to investors: Continued value creation through growth (I)



Q3 FY16 revenue y-y growth ~3%, despite shrinking market



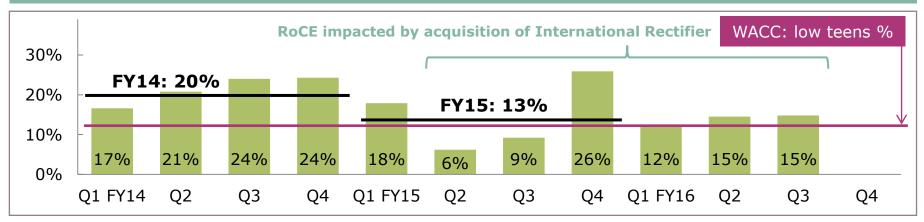
Earnings-per-share growth



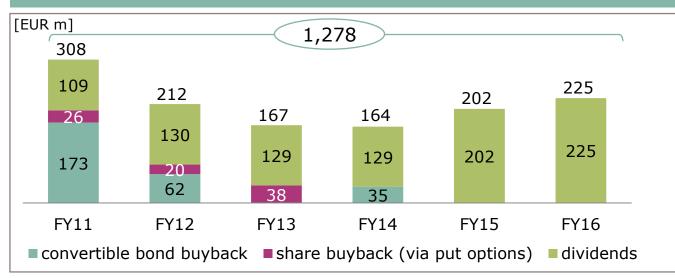
Our promise to investors: Continued value creation through growth (II)



RoCE as key value metric



Total cash return to shareholders



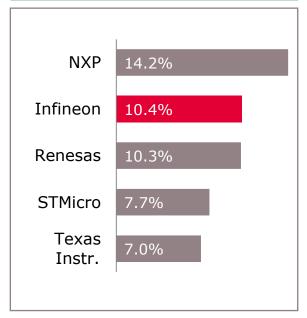
- Policy of sustainable dividend payout.
- Increase of dividend from €0.18 to €0.20.
- Payout of €225m on 19 Feb 2016.

Infineon increased relative market share in power and outperformed chip card market



Automotive semiconductors

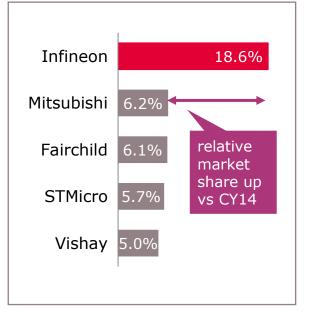
total market in 2015: \$27.4bn



Source: Strategy Analytics, April 2016

Power discretes and modules

total market in 2015*: \$14.8bn

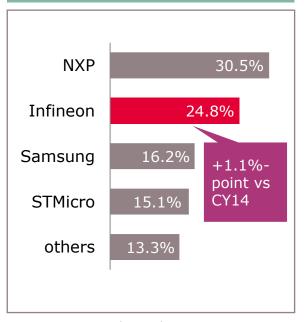


Source: IHS Markit, July 2016

* preliminary figures

Smart Card ICs

total market in 2015: \$2.72bn



Source: IHS Markit, July 2016

Tight customer relationships are based on system know-how and app understanding



ATV



IPC



PMM



CCS



EMS partners













Distribution partners









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Key facts of the deal

Transaction perimeter:



CREE ♣′s

SiC wafer substrate business (excluding LED)

Revenues of US\$173m in LTM* ending 27 March 2016

> Purchase price: US\$ 850m

Transaction type: cash and debt free

Financing: US\$ 720m bank loans

US\$ 130m cash-on-hand

Expected closing date: ~ end of calendar year 2016

^{*} LTM = last twelve months



Deal rationale at a glance







GM 55%*

CAGR 20%

- Become #1 in RF power amplifier market by ~2020 with most complete technology portfolio by capitalizing on technology disruption in cellular infrastructure
- #1 in silicon carbide for power, strengthen automotive and industrial and accelerate market introduction with cutting-edge products as cost-performance leader and create thereby a higher addressable market for Infineon
- Deal is margin and adjusted EPS accretive from day 1 with expected 55% incremental gross margin* and 20% incremental revenue growth of the acquired businesses
- For detailed information on the deal rational please refer to the web call and the corresponding investor presentation at http://www.infineon.com/poweringthefuture

^{*} According to US GAAP, excluding effects from purchase price accounting



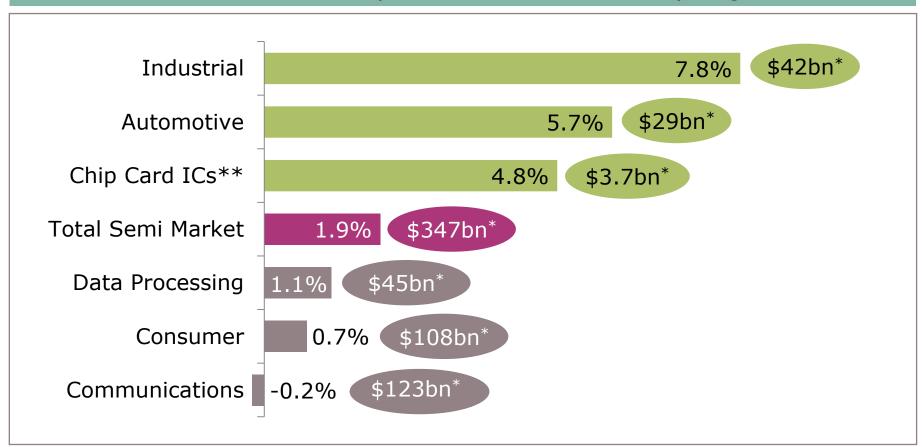
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Infineon benefits from industrial, auto and security, the by far fastest growing segments



CAGR 2015 – 2020 by Semiconductor Industry Segment



Source: IHS Markit, Worldwide Semiconductor Shipment Forecast, June 2016

^{*} In calendar year 2015

^{**} source: ABI Research, "Secure Smart Card & Embedded Security IC Technologies", January 2016; microcontroller ICs

Infineon is system leader in automotive; making cars clean, safe and smart



#2 with market share gains in power and sensors:

- #1 in power semiconductors*
- #2 in sensors*
- #3 in microcontrollers* (#1 in powertrain**)

Most balanced portfolio with sensors, microcontrollers and power for system approach

Leader in electric drivetrain and CO₂ reduction - making cars clean

Leader in ADAS

- making autonomous driving safe and reliable

Leading product portfolio of sensors and security ICs for individual convenience and connectivity - making cars smart

Focus on sustainable high-bill-of-material areas: powertrain, safety/ADAS/autonomous cars, body

Infineon is ideally positioned to benefit from megatrends and to gain further market share in Automotive

for more information see presentation at:

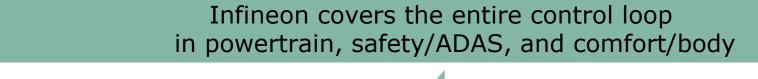
www.infineon.com/autoslides

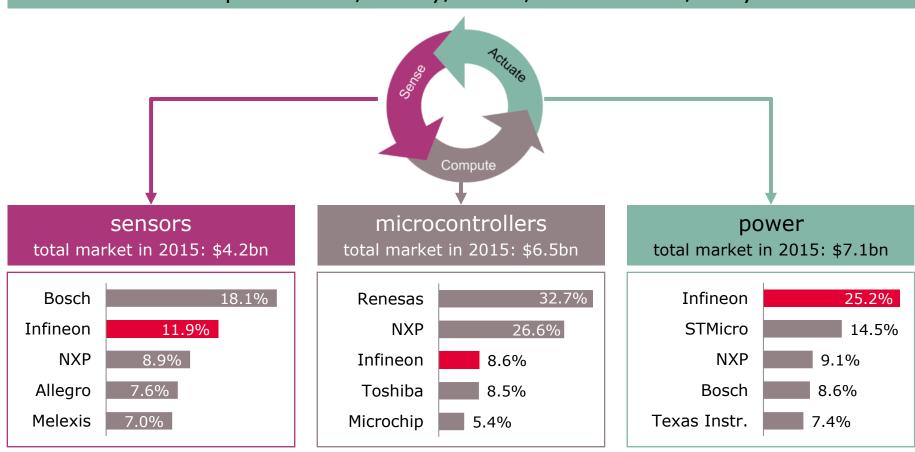
^{*} Source: Strategy Analytics, April 2016

^{**} own estimate.

Infineon is system leader with most balanced portfolio in the market







Source: Strategy Analytics, "Automotive Semiconductor Vendor Market Shares", April 2016

Four megatrends are shaping the automotive market, significantly increasing the semi content per vehicle



ADAS/Autonomous driving

- From ADAS to semi-automated and finally autonomous driving
- Every world region is striving for "0-accident"

xEV/eMobility

 Mandated CO₂ reductions make electrification of powertrain inevitable



- Advanced connectivity is driven by making the car part of the Internet

Automated

The car will be fully connected (V2I, V2V, in-vehicle)



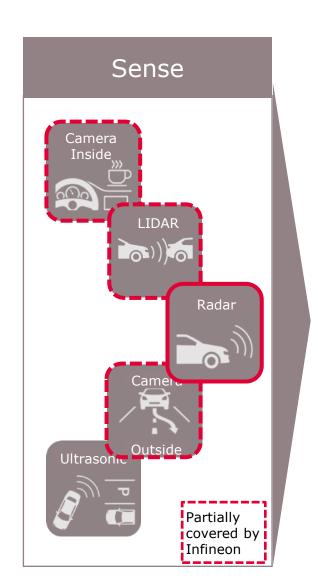
- Increased connectivity and software content increase risk exposure to hackers
- Internal/external connectivity must be secured

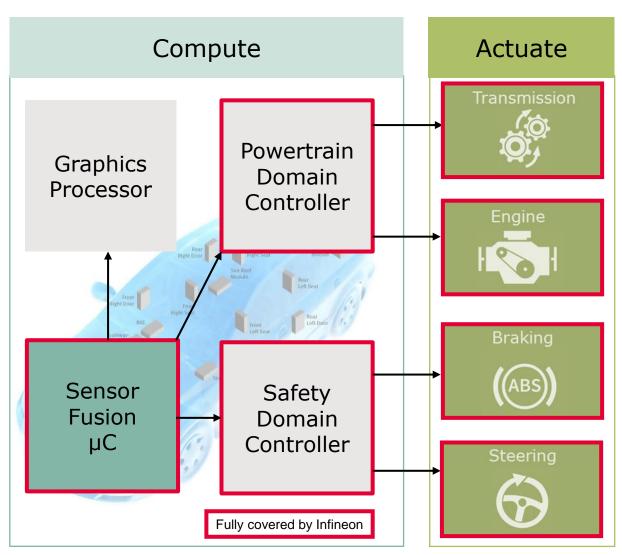
Connectivity

Advanced security



ADAS system chipset coverage by Infineon

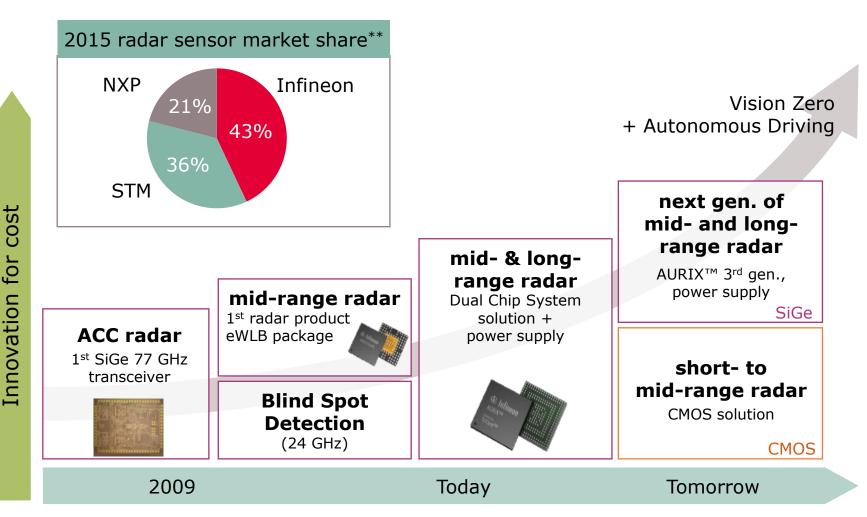




Innovation for performance

Infineon market leader in radar; 20m sensor chips sold; \sim 50% CAGR₁₆₋₂₁ based on design wins*





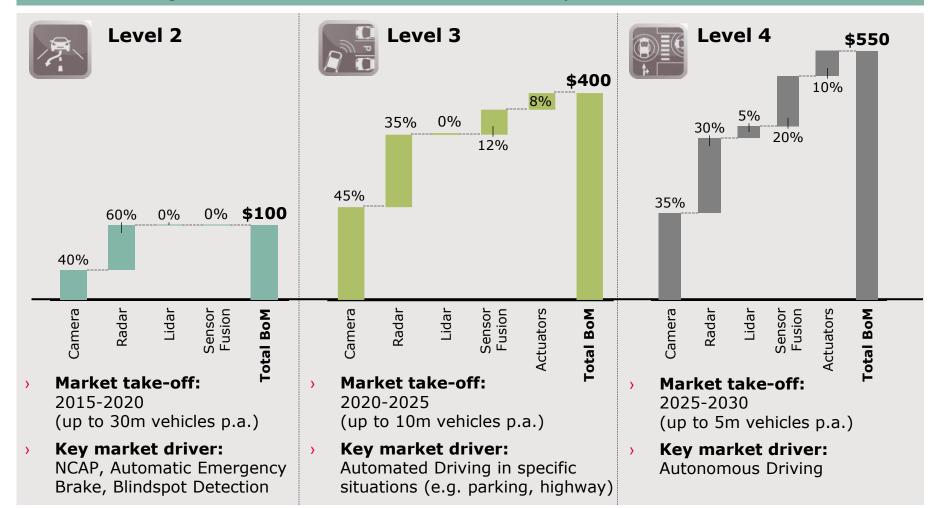
^{*} Refers to 77 GHz radar sensor chip market

^{**} Source: IHS Markit, "Advanced Driver Assistance Applications Sensor Market Database – H2 2015", February 2016

ADAS semi growth driven by radar and camera sensor modules



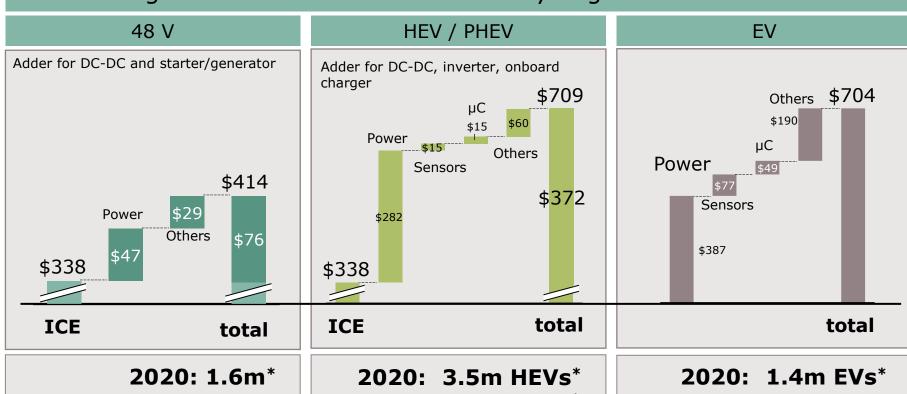
Average ADAS semiconductor content per level of automation





xEV growth driven by power semis

Average xEV semiconductor content by degree of electrification



high growth for 48 V (not even including 48 V auxiliaries nor mild hybrid)

1.9m PEHs*

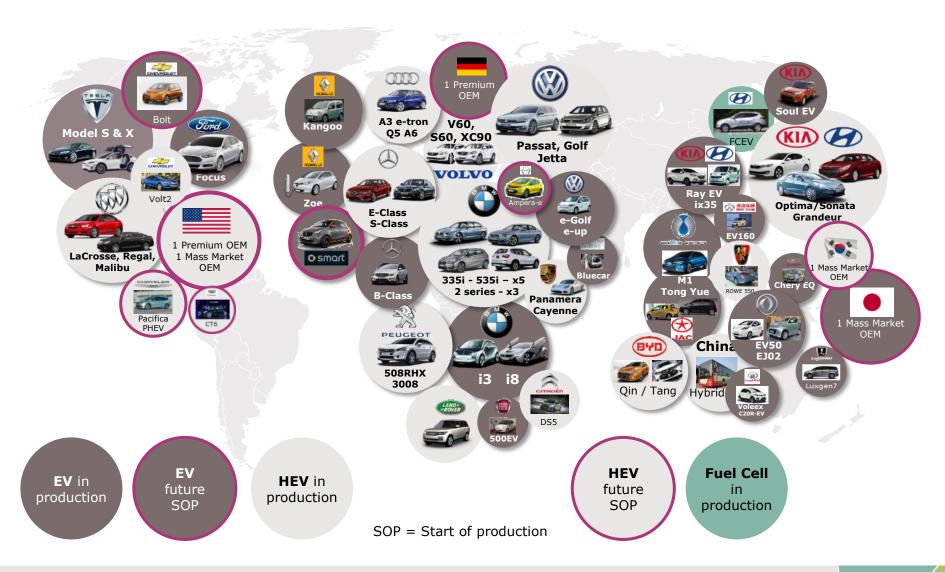
> PHEV to overtake HEV after 2020, especially in Europe

strong growth driven by Chinese OEMs and Tesla

^{*}Source: IHS Markit, "Alternative Propulsion Forecast", January 2016, expected number of vehicles

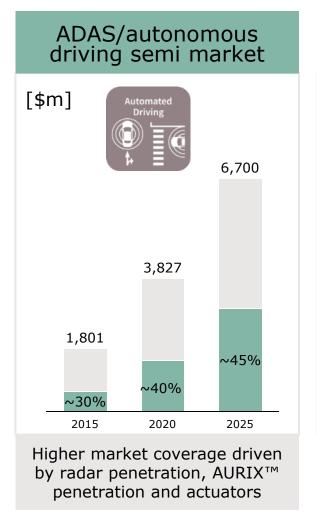
Infineon is well positioned globally to benefit disproportionally from xEV boom

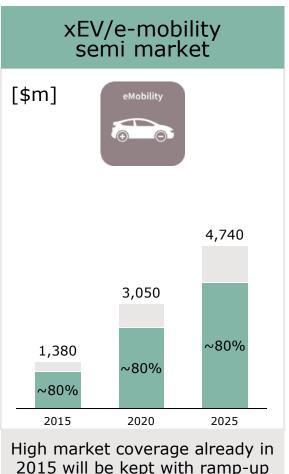


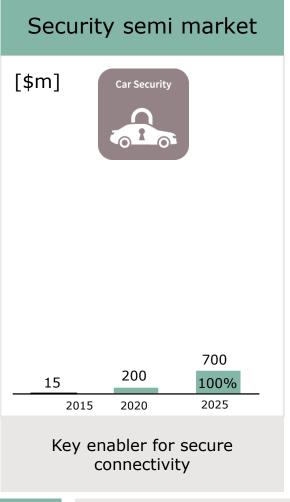


Infineon is ideally positioned to benefit most from megatrends ADAS, xEV, and security









Source: IHS Markit, Strategy Analytics, Infineon estimations

Addressed by Infineon

Not addressed by Infineon

of new power products

ADAS, CO₂ reduction and adoption of premium features drive Infineon growth



Vehicle production

- \sim 2% growth p.a.
- Further growth in Western Europe, US, Korea and China
- Electro-mobility gaining momentum, especially in China

Drivers for semiconductor content per car

CO₂ reduction



- Driven by legislation
- Improvements of ICE (e.g. electric steering, electric pumps and motors)
- Adoption of EV/HEV

Advanced safety



- Current: crash avoidance
- Next: assisted Driving
- > Future: autonomous driving

Comfort, premium



- Premium cars are early adopters of high-end comfort and safety features
- Trickling down to midrange

~8% p.a. through-cycle growth

Infineon is #1 and technology leader in power semiconductors



#1 in the market*

Broadest product and technology portfolio

Addressing broadest range of applications

300 mm thin-wafer manufacturing for power semiconductors

System leader with digitalization of the control loop and functional integration

Leader in next-generation power semiconductor materials GaN and SiC

Infineon is ideally positioned to gain further market share and earn superior margins in power semiconductors

^{*} Source: IHS Markit, "Power Semiconductor Discretes & Modules Report – 2016", July 2016

As system leader in power, Infineon has broadest application and technology reach

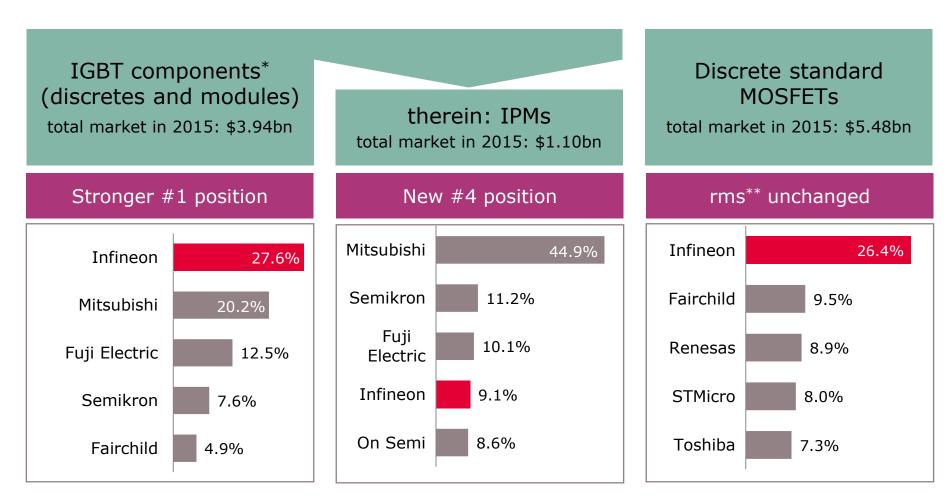


Covering the entire power chain Generation **Transmission** Consumption Main IPC markets Main PMM power markets System competence for highest reliability and highest efficiency **Stacks** MOSFETs/IGBTs Modules Controllers **Drivers** I≎R

CHiL®

Infineon further strengthened its market positions





^{*} The market for IGBT components (\$3,944m) includes discrete IGBTs (\$853m), Standard IGBT modules (\$1,692m), CIB/PIM (\$299m), and IPMs (\$1,101m).

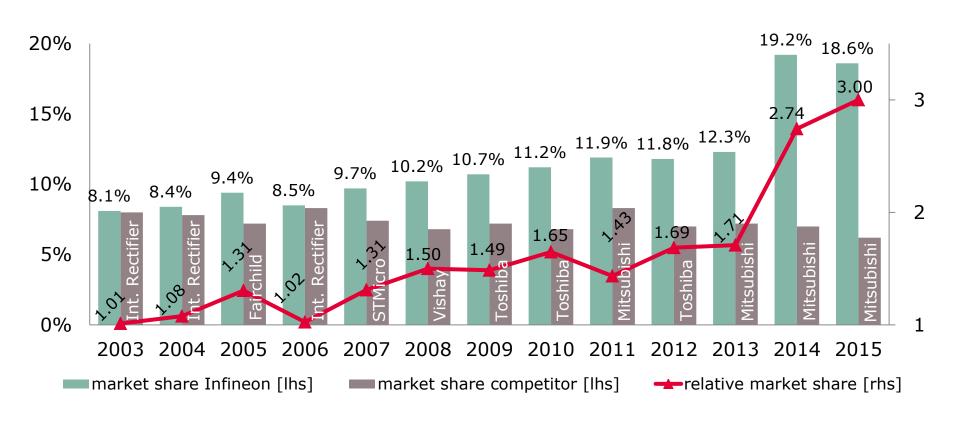
Source: IHS Markit, "Power Semiconductor Discretes & Modules Report", July 2016; preliminary figures

^{**} relative market share

Infineon continuously improved relative market share in power



Relative market share* of 3 in the total power semiconductor market



^{*} The relative market share is defined as the proportion of the market share held by the market leader (in all years presented for Infineon) compared to the market share of the second largest competitor in the relevant year.

Source: IHS Markit, several reports from 2004 through 2016; preliminary figures for CY15

Strong #1 position in power allows driving of key areas of differentiation and innovation



Unique 300 mm thin wafer power semiconductor manufacturing

Compound semiconductors GaN and SiC

Digitalization of the power control loop

Functional integration of IGBT modules

Efficiency and digitalization are main market drivers for power applications



IPC PMM

Drives

Renewables



MHA

















- Energy efficiency
- Automation
- Productivity increase
- Legislation
- Growing share of renewable energies as part of the energy generation mix
- Growing population in metropolitan areas
- Fast and efficient mass transport system
- Energy efficiency
- Growing VSD penetration
- Energy efficiency
- Charging time
- Compactness (power density)
-) DPM

- Energy efficiency
- Compactness (power density)
- DPM
- Brushless DC motors

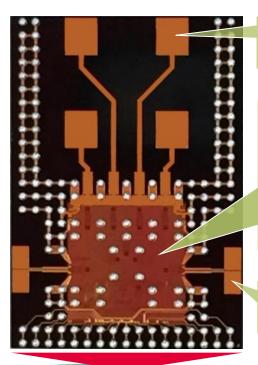
DPM = Digital Power Management

MHA = Major Home Appliances

VSD = Variable Speed Drive

Sensors drive multimarket segment in PMM: 60 GHz radar transceiver for gesture sensing

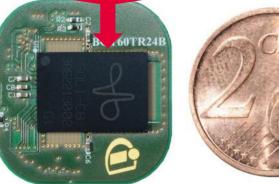




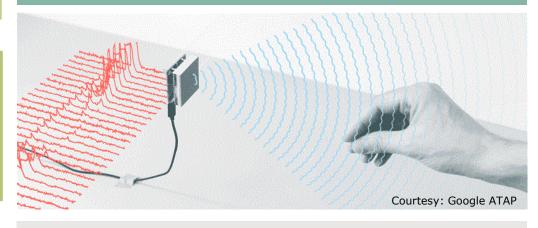
4 receive antennas

RF frontend, baseband, ADC, state machine, memory

2 transmit antennas



Presented at "Google I/O 2016"*



- 1.8 V for the complete chip set
- > 54 mW power consumption in sensing mode
- > supports > 1,000 frames per second





* See YouTube: https://www.youtube.com/watch?v=8LO59eN9om4

Infineon REAL3™ image sensor is first to meet Google Tango specification



Lenovo PHAB2 Pro first smartphone based on Google Tango

- depth perception of the surrounding in real-time
- motion tracking which responds to physical movements
- area learning capability which enables the device to recall the data recorded from previously visited locations







REAL3™ will drive multiple new applications

- automotive: driver monitoring
- consumer: indoor navigation, education
- gaming: Pokémon Go is a remarkable AR technology demonstrator; leading game developers will incorporate AR technology in new games
- AR seems to have scored over VR by ease of accessibility: AR games can be used on mobile phones, whereas VR needs rather expensive headsets and tremendous computing power

Infineon is the leader in security solutions for the connected world



#2 in microcontroller-based smart card ICs*

#1 in embedded digital security**

Complete portfolio of hardware, software, services and turn-key solutions

Leading in growth segments payment, government ID, connected car security, IoT, and Information and Communications
Technology security

Infineon is ideally positioned to benefit from the growth trends in the security controller market

Source: IHS Markit, July 2016

^{**} Source: IHS Markit, December 2015

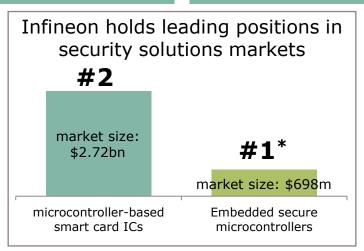
CCS is enabling security for the connected world



Smart card applications

Embedded security applications







- Smart card payment
- Electronic passports and ID documents
- Mobile communication
- Transport ticketing

- Mobile device security and payment
- Information and Communications
 Technology security
- Industrial and automotive security
- IoT connected device security

















Source: IHS Markit, Dec 2015, July 2016; * based on units; USD-ranking not provided

Recent design-wins underline Infineon's #1 position* in embedded digital security



Recent design-wins for OPTIGA™ family products

- Servers and gateways
- Notebooks,e.g. Lenovo ThinkPad
- Industry PCs
- Tablets,e.g. Microsoft Surface Pro 4
- Smart home hub, e.g. Google OnHub



Courtesy: Lenovo



Courtesy: Google

^{*} Infineon is market leader in embedded secure microcontrollers with 31% market share (ranking based on units). Source: IHS Markit, "Embedded Digital Security Report", January 2016

Infineon's long-term growth is based on sustainable growth drivers



ATV

Courtesy: BMW Group

- CO₂ reduction
- Advanced Driver Assistance Systems

IPC



- Energy efficiency
- Automation
- Productivity increase

PMM



- Energy efficiency
- Power density
- BLDC motors
- Mobile device and LTE growth

CCS



- Security as a function
- Mobile payments
- Authentication
- Internet of Things

~8% p.a. through-cycle growth

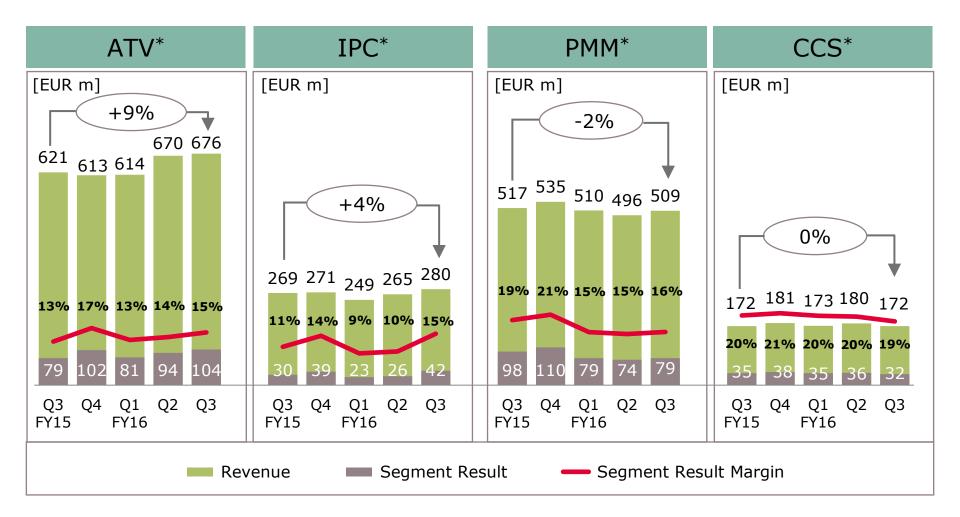


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Strong growth in ATV due to ADAS and electro-mobility





^{*} The business with XMC industrial microcontrollers developed by ATV and CCS was transferred to PMM and IPC with effect from 1 October 2015. The previous year's figures have been adjusted accordingly.



Guidance for Q4 FY16 and total FY16

	Outlook Q4 FY16* (compared to Q3 FY16)	Outlook FY16 (compared to FY15)	
Revenue	Increase of 3% +/- 2%-points	Based on the outlook for Q4 FY16, revenue growth and Segment Result Margin for FY16 are expected to	
Segment Result Margin	At the mid-point of the revenue guidance: 17%	finish within the range forecast in the preceding quarters**.	
Investments in FY16		About €850m	
D&A in FY16		About €850m***	

^{*} Based on an assumed average exchange rate of \$1.10 for €1.00.

On 02 February 2016 based on an exchange rate of \$1.10 for €1.00: "Revenue to increase by 13% +/- 2%-points; SR margin to come in at 16% at the mid-point of the revenue guidance".

On 03 May 2016 based on an exchange rate of \$1.15 for €1.00: "Revenue to increase by 12% +/- 2%-points; SR margin to come in between 15% and 16% at the mid-point of the revenue guidance".

^{***} Including D&A on tangible and intangible assets from purchase price allocation of International Rectifier.



Part of your life. Part of tomorrow.



Solid Investment Grade rating assigned by S&P in connection with revised capital structure targets



Revised capital structure targets announced by Infineon in February 2016:

a.) Gross Cash

b.) Gross Debt

»€1bn plus 10% to 20% of revenue"

> "less than 2.0x EBITDA"

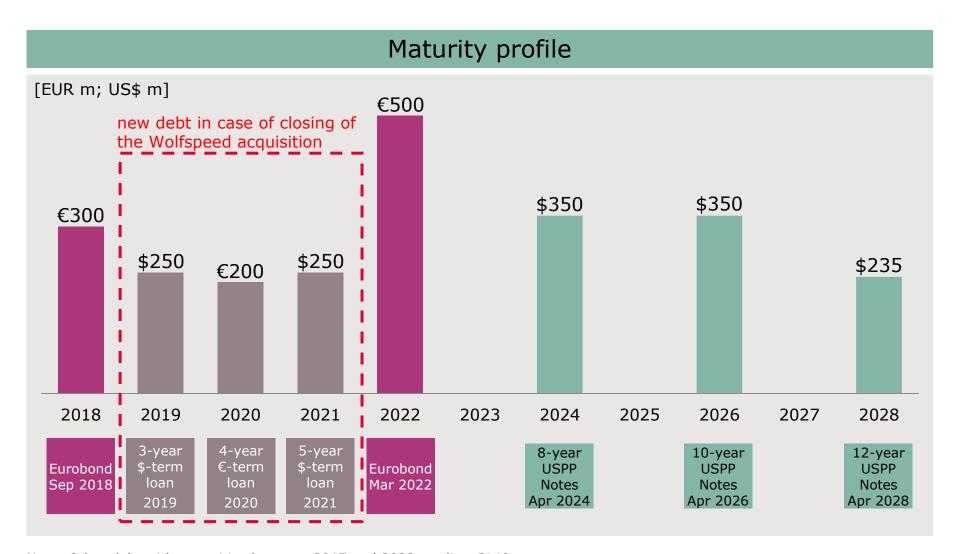
S&P GlobalRatings

Infineon's revised capital structure targets are reflected in the Corporate Credit Rating of **BBB** (outlook: "stable") assigned by S&P in February 2016.

Rating not changed after announcement of planned Wolfspeed acquisition



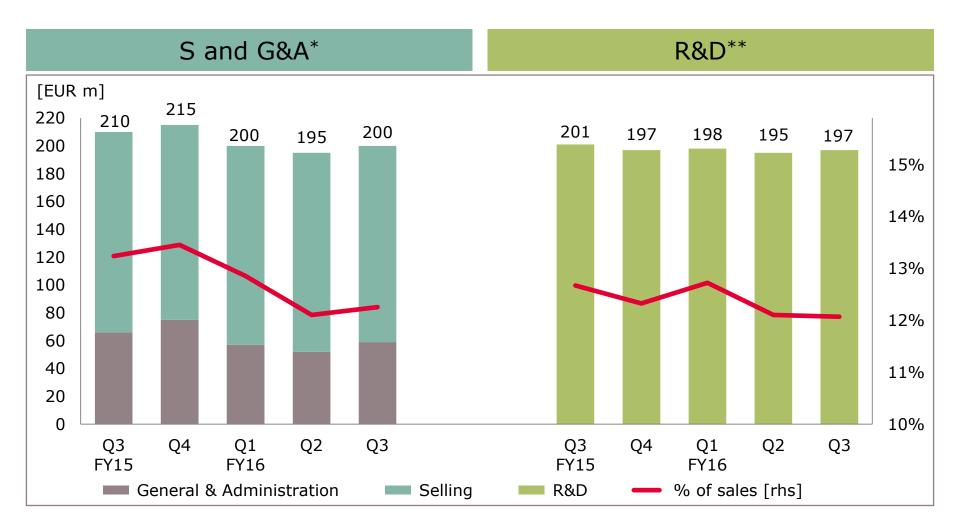
Infineon has a well balanced maturity profile



Note: Other debt with maturities between 2017 and 2023 totaling €149m.

SG&A still includes noticeable acquisitionrelated costs that are incrementaly declining



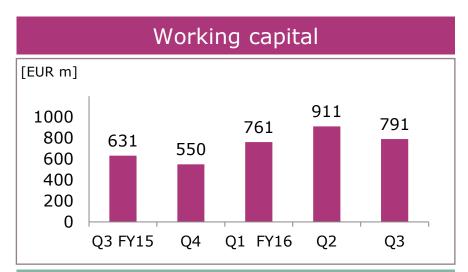


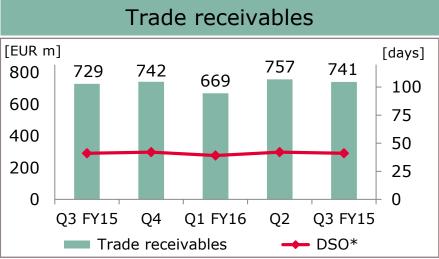
^{*} Target range for SG&A: "Low teens percentage of sales".

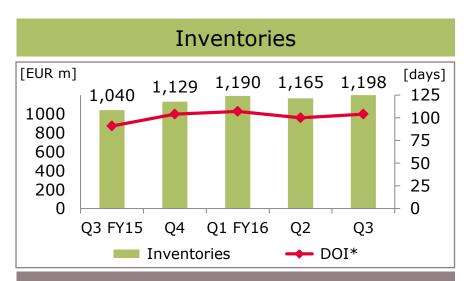
^{**} Target range for R&D: "Low to mid teens percentage of sales".

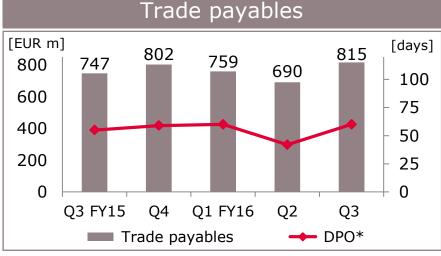
Improved working capital due to increased payables







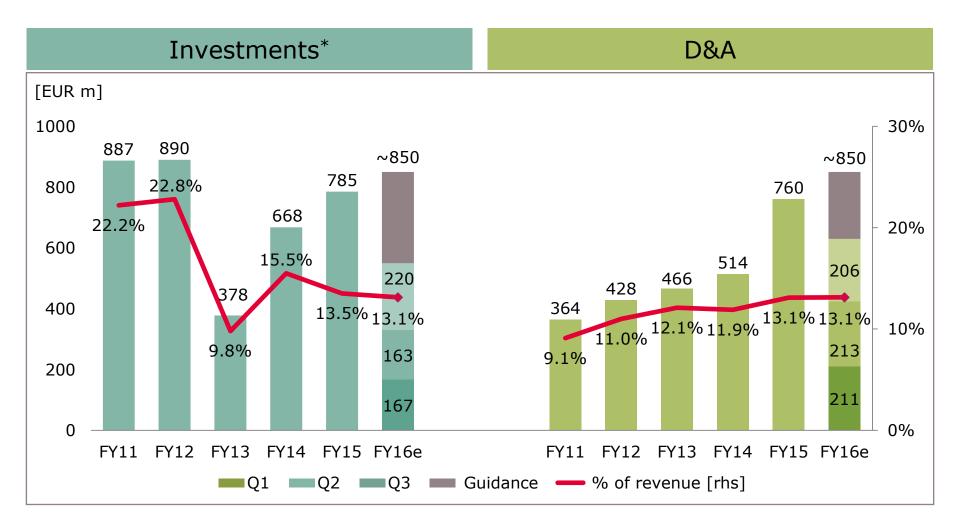




^{*} For definition please see page 48.

Investments on target of ~13% of sales; D&A stable at ~13% of sales

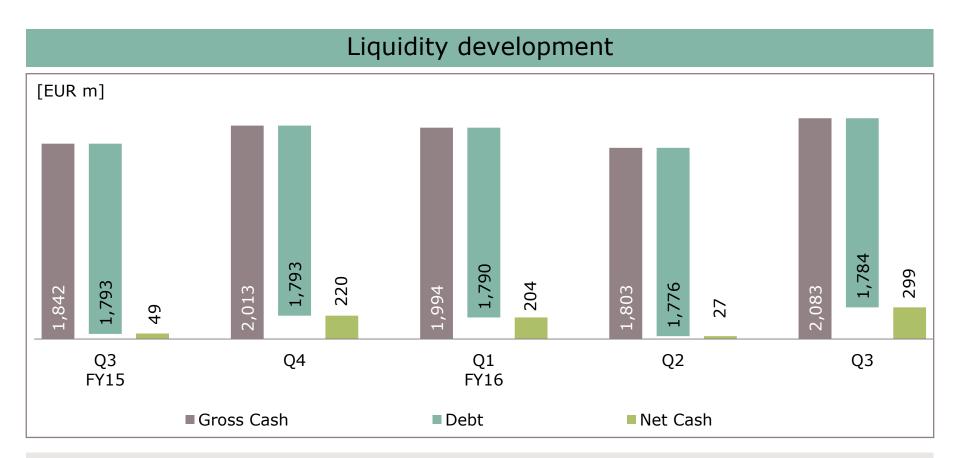




^{*} For definition please see page 48.

Net cash increased due to €277m Free Cash Flow

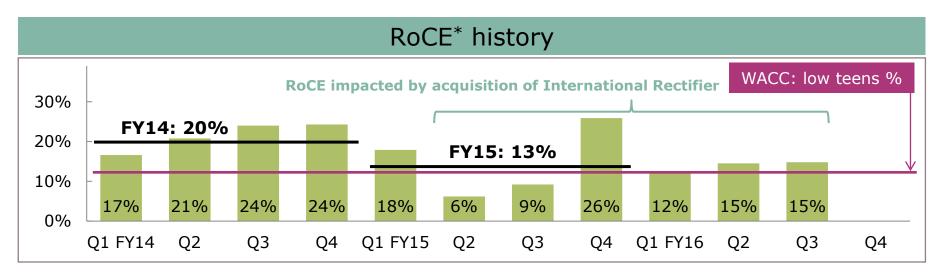


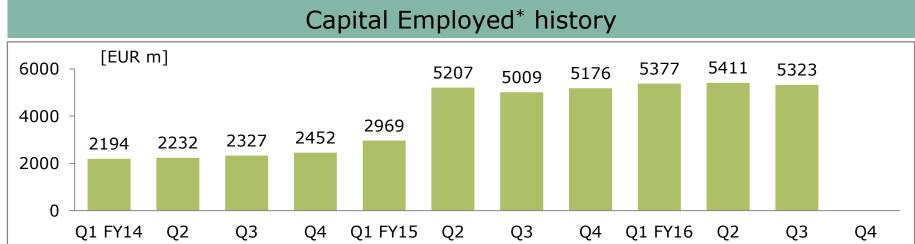


> Free Cash Flow from continuing operations was €277m, significantly up from €45m in Q2. This is basically a timing effect in terms of certain trade payables



RoCE expected to increase in FY16 vs FY15





^{*} For definition please see page 48.



Notes

Investments =

'Purchase of property, plant and equipment'

+ 'Purchase of intangible assets and other assets' incl. capitalization of R&D expenses

Capital Employed =

'Total assets'

- 'Cash and cash equivalents'
- 'Financial investments'
- 'Assets classified as held for sale'
- ('Total Current liabilities'
 - 'Short-term debt and current maturities of long-term debt'
 - 'Liabilities classified as held for sale')

RoCE =

NOPAT / Capital Employed = ('Income from continuing operations'

- 'financial income'
- 'financial expense')

/ Capital Employed

DOI (days of inventory; quarter-to-date) = ('Net Inventories' / 'Cost of goods sold') * 90

Please note:

All positions in ' ' refer to the respective accounting position and therefore should be applied with the positive or negative sign used in the relevant accounting table.

Working Capital =

('Total current assets'

- 'Cash and cash equivalents'
- 'Financial investment'
- 'Assets classified as held for sale')
- ('Total current liabilities'
 - 'Short term debt and current maturities of long-term debt'
 - 'Liabilities classified as held for sale')

DSO (days sales outstanding; quarter-to-date) = ('Trade receivables' / 'revenue') * 90

DPO (days payables outstanding; quarter-to-date) = ('Trade payables' / ['Cost of goods sold' + 'Purchase of property, plant and equipment']) * 90

Infineon is a long-standing member of Europe's leading sustainability indices



Infineon's most recent achievements

MEMBER OF

Dow Jones Sustainability Indices

In Collaboration with RobecoSAM (

- Jan 2016: Infineon is listed in the Sustainability Yearbook for the sixth consecutive year and, according to RobecoSAM, among the top 15% most sustainable companies worldwide.
- Sep 2015: Infineon was listed in the Dow Jones Sustainability Index for the sixth consecutive year. Additionally, Infineon was accepted into the World Index for the first time and as the only European semiconductor company.

 Sep 2015: Infineon was listed in the STOXX®
 Global ESG Leaders Indices, which serves as an indicator of the quality



of Infineon's performance in the governance, social and environmental areas (ESG).



- Infineon was added to the FTSE4Good Index Series in 2001 and has been confirmed as a member since then.
- Jul 2016: Most recent review.
- Dec 2015: In the Carbon Disclosure Project (CDP) climate change report, Infineon achieved a placing among the best companies in the Information Technology sector.



Financial calendar

Date	Location	Event
01 Sep 2016	Frankfurt	Commerzbank Sector Week
06 - 07 Sep 2016	New York	Citi Global Technology Conference
08 - 09 Sep 2016	London	Deutsche Bank European TMT Conference
19 Sep 2016	Munich	Berenberg Bank and Goldman Sachs German Corporate Conference
21 Sep 2016	Munich	Baader Investment Conference
16 – 17 Nov 2016	Barcelona	Morgan Stanley TMT Conference
23 Nov 2016*		Q4 FY16 and FY 2016 Results
29 – 30 Nov 2016	Scottsdale, AZ	Credit Suisse TMT Conference
02 Feb 2017*		Q1 FY17 Results
16 Feb 2017	Munich	Annual General Meeting
04 May 2017*		Q2 FY17 Results
01 Aug 2017*		Q3 FY17 Results
30 Nov 2017*		Q4 FY17 and FY 2017 Results

^{*} preliminary



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